



Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C		
20V	56mΩ @ V _{GS} = 4.5V	2.8A		
	65mΩ @ V _{GS} = 2.5V	2.6A		
	93mΩ @ V _{GS} = 1.8V	2.2A		
	140mΩ @ V _{GS} = 1.5V	1.8A		

Description and Applications

This MOSFET has been designed to minimize the on-state resistance $(R_{DS(ON)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- General Purpose Interfacing Switch
- Power Management Functions
- DC-DC Converters
- Analog Switch

20V N-CHANNEL ENHANCEMENT MODE MOSFET

Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate
 Datasheet (DMN2065UWQ)

Mechanical Data

- Case: SOT323
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Alloy42 Leadframe. Solderable per MIL-STD-202, Method 208 3
- Weight: 0.027 grams (Approximate)

SOT323 Gate Top View Construction Constr

Ordering Information (Note 4)

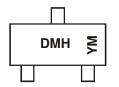
	Part Number	Case	Packaging
	DMN2065UW-7	SOT323	3000/Tape & Reel
Notes:	1. No purposely added lead. Fully EU Dire	ective 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/	/863/EU (RoHS 3) compliant.

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 See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

- Lead-free.
 Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and
- Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



DMH = Product Type Marking Code YM = Date Code MarkingY = Year (ex: F = 2018)

M = Month (ex: 9 = September)

Date Code Key

Year	201	8	2019		2020		21	2022		2023	2	2024	
Code	F		G		Н			J		K		L	
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec	
Code		0	2	4	5	e	7	0	0	\cap	NI	П	



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	20	V		
Gate-Source Voltage	V _{GSS}	±12	V		
	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	2.8 2.3	А
Continuous Drain Current (Note 6) $V_{GS} = 4.5V$	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	3.1 2.6	А
	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	2.2 1.7	А	
Continuous Drain Current (Note 6) $V_{GS} = 1.8V$	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	2.4 1.9	А
Pulsed Drain Current (10us Pulse, Duty Cycle=1%)	IDM	30	А		
Maximum Body Diode Forward Current (Note 5)			ls	1.2	А

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

	Symbol	Value	Unit
	PD	0.43	W
Steady State		296	°C/W
t<10s	Π _θ JΑ	252	°C/W
	Po	0.7	W
Steady State		178	°C/W
t<10s	R ₀ JA	151	°C/W
	T _J , T _{STG}	-55 to +150	°C
	t<10s Steady State	PD Steady State t<10s	PD 0.43 Steady State 296 t<10s

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Oh ann ata riatia		Min			11	To at Oam dition
	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)			-			
Drain-Source Breakdown Voltage	BV _{DSS}	20	-	-	V	$V_{GS} = 0V, I_D = 1mA$
Zero Gate Voltage Drain Current @Tc = +25°C	IDSS	-	-	1	μA	$V_{DS} = 20V, V_{GS} = 0V$
Gate-Source Leakage	IGSS	-	-	±1	μA	$V_{GS} = \pm 10V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	0.35	-	1.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
		-	52	56		$V_{GS} = 4.5V, I_D = 2A$
Static Drain-Source On-Resistance	Descent	-	59	65	mΩ	$V_{GS} = 2.5V, I_D = 2A$
Static Drain-Source Off-Hesistance	R _{DS} (ON)	-	60	93	11152	$V_{GS} = 1.8V, I_D = 1A$
		-	75	140		$V_{GS} = 1.5V, I_D = 0.5A$
Forward Transfer Admittance	Y _{fs}	-	7	-	S	$V_{DS} = 5V, I_D = 3.8A$
Diode Forward Voltage	V _{SD}	-	0.7	1.0	V	$V_{GS} = 0V, I_{S} = 1A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	-	400.0	-	pF	10V V 0V
Output Capacitance	Coss	-	73.8	-	pF	−V _{DS} = 10V, V _{GS} = 0V, −f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	-	65.6	-	pF	
Total Gate Charge	Qg	-	5.4	-	nC	$V_{GS} = 4.5V, V_{DS} = 10V,$
Gate-Source Charge	Qgs	-	0.7	-	nC	$I_D = 6A$
Gate-Drain Charge	Q _{gd}	-	1.4	-	nC	
Turn-On Delay Time	t _{D(ON)}	-	3.5	-	ns	
Turn-On Rise Time	t _R	-	9.7	-	ns	$V_{DD} = 10V, V_{GS} = 5V,$
Turn-Off Delay Time	t _{D(OFF)}	-	23.8	-	ns	$R_L = 1.7\Omega, R_G = 6\Omega$
Turn-Off Fall Time	tF	-	7.2	-	ns	

Notes:

Device mounted on FR-4 substrate PC board, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

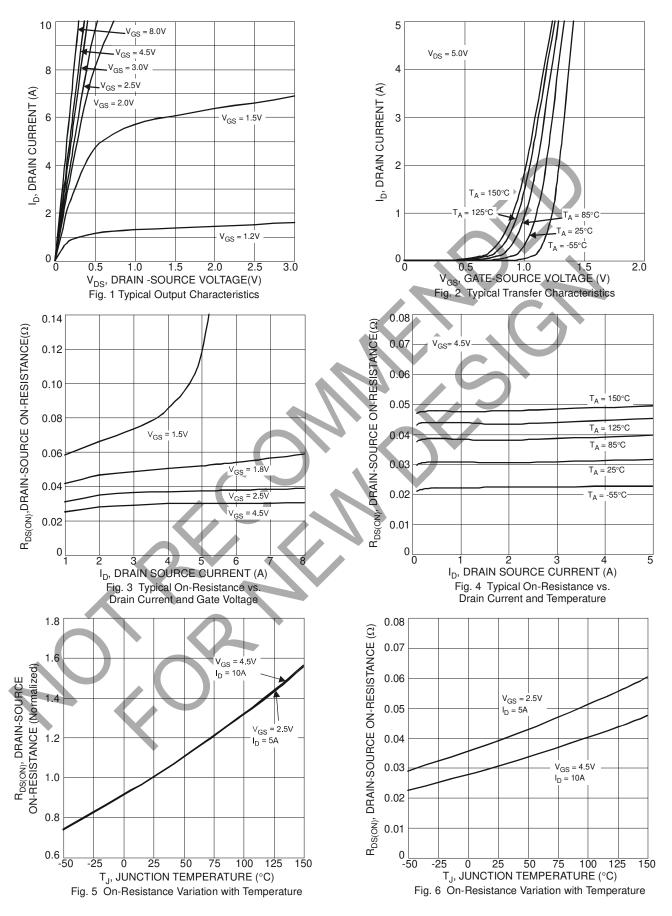
7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.



NOT RECOMMENDED FOR NEW DESIGN USE <u>DMN2058UW</u>

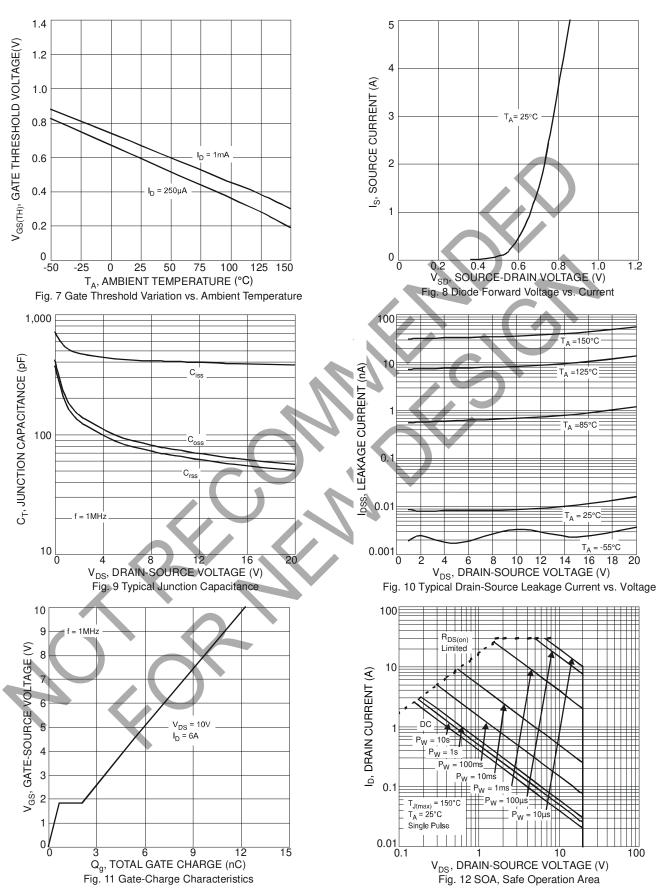
DMN2065UW





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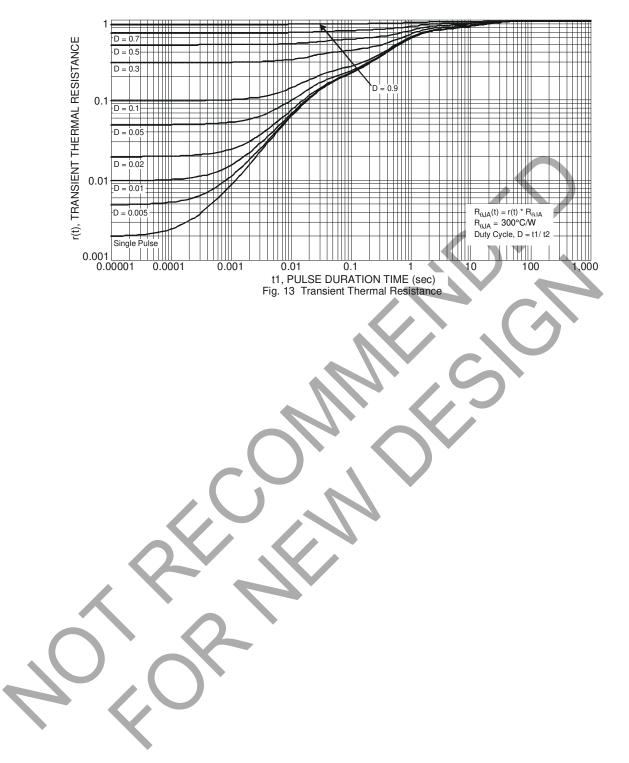
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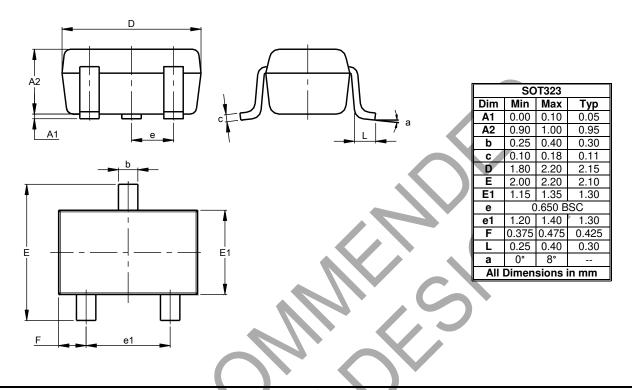




Package Outline Dimensions

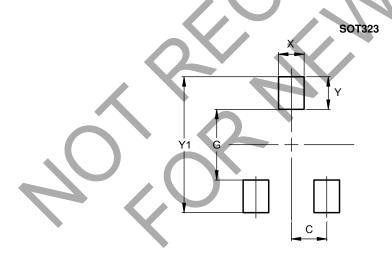
Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT323



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	0.650
G	1.300
Х	0.470
Y	0.600
Y1	2.500



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